

	Type	Hits	Search Text	DBs
1	IS&R	1	("5855049").PN.	USPAT; USOCR
2	BRS	6	(RE37865 or "6354000" or "6414361" or "6417027" or "6031286" or "6049975").pn.	USPAT
3	BRS	2635	(drilling or machining) with plating	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
4	BRS	1437	drilling with plating	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
5	BRS	341	S4 and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
6	BRS	22	S5 and (seed adj layer) and sputter\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB

	Type	Hits	Search Text	DBs
7	BRS	0	(sidewall adj plating) with trench	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
8	BRS	55	(sidewall adj plating)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
9	BRS	39	S8 and (trench or via)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
10	BRS	15	S8 and (trench or via) and sputter\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB
11	BRS	6783	29/831,846,847,852.cccls. or 257/734.cccls. or 438/597,667-669,672,678,679.cccls.	US-PGPUB; USPAT

	Type	Hits	Search Text	DBs
12	BRS	5123	S11 and (trench or via or hole or mesa)	US-PGPUB; USPAT
13	BRS	93	S12 and (plat\$3 with sidewall)	US-PGPUB; USPAT
14	BRS	38	S13 and sputter\$3	US-PGPUB; USPAT
15	BRS	12	Jordan.IN. and multilevel	US-PGPUB; USPAT
16	BRS	206	Jordan.IN. and conductor	US-PGPUB; USPAT